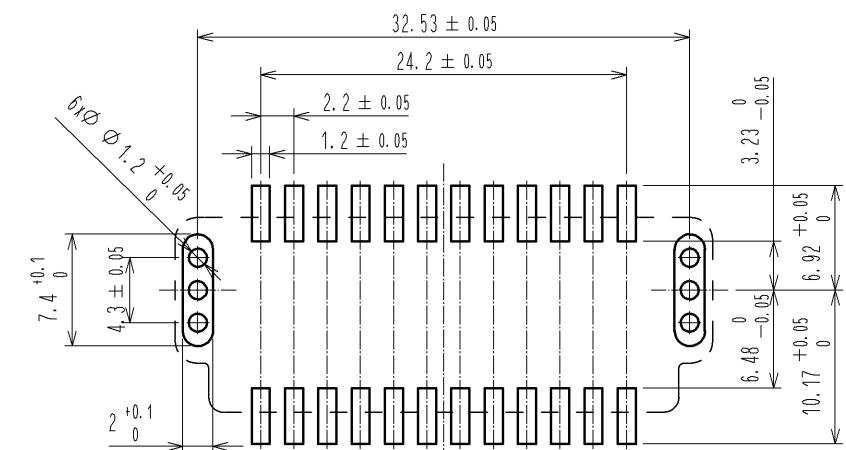
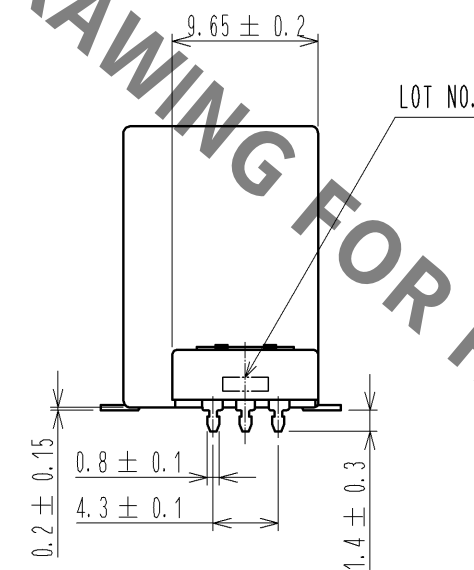
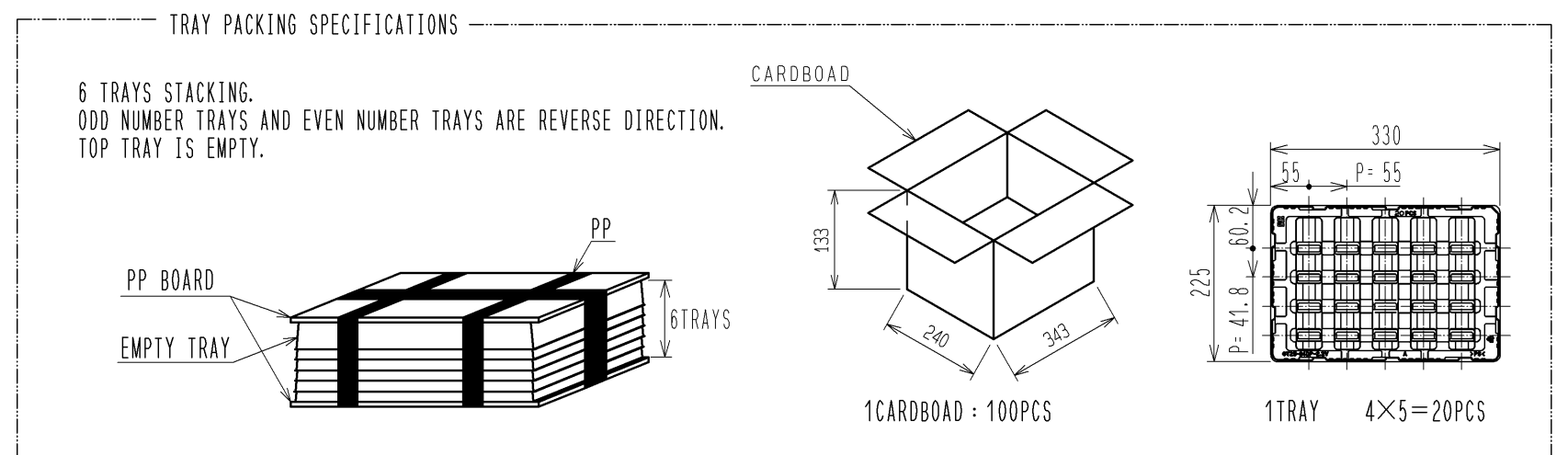
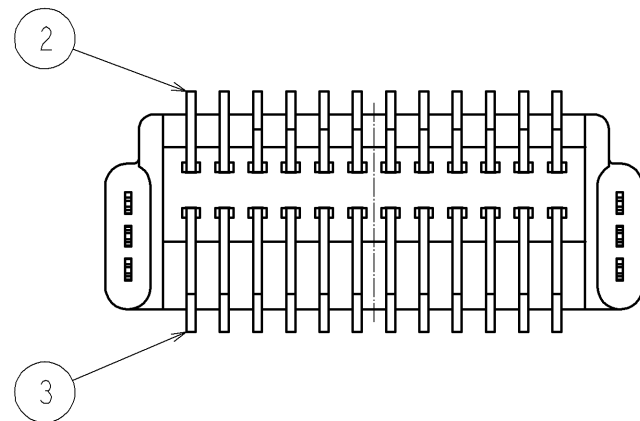
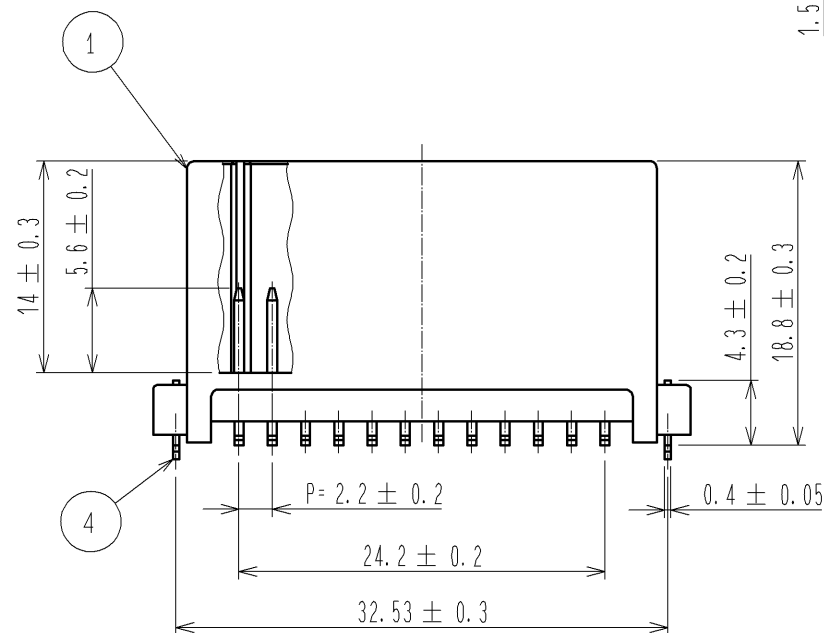
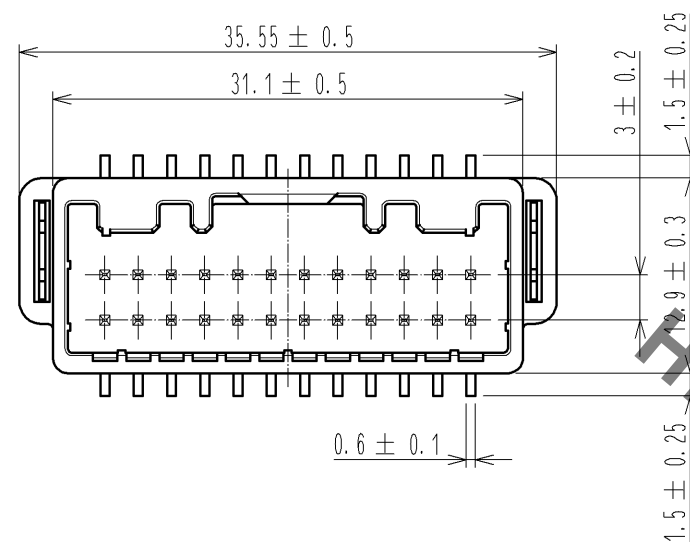
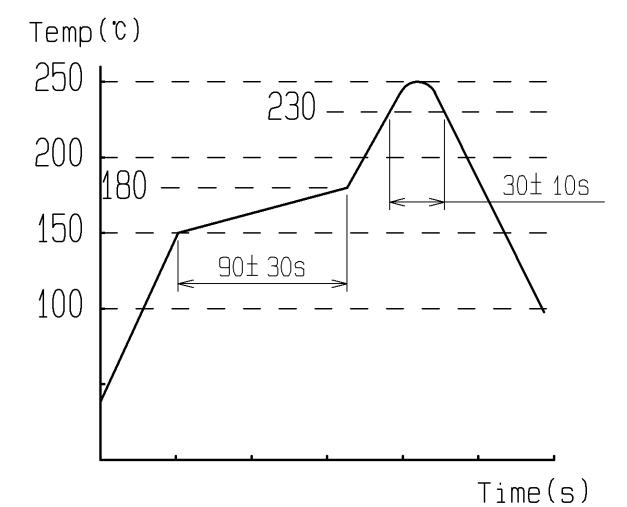


ELV, RoHS COMPLIANT



- NOTE1. RECOMMENDED TEMPERATURE PROFILE FOR REFLOW
(REFER TO RIGHT FIG.)
USED REFLOW SYSTEM
- IR IN THE AIR OR NITROGEN
NO. OF CYCLES : 2 MAX
PEAK : 250°C
OVER 230°C : 20~40s
PREHEAT : 150~180°C
60~120s
2. TEMPERATURE FOR SOLDERING IRON
: 280~300°C WITHIN 2s
3. CO-PLANARITY SHALL BE 0.1 MAX.
4. PC BOARD THICKNESS=1.6.
5. RECOMMENDED SOLDER THICKNESS=0.15



2	BRASS	TIN PLATED	T=0.64	4	BRASS	TIN PLATED	T=0.4
1	PPS	LIGHT GRAY		3	BRASS	TIN PLATED	T=0.64
NO.	MATERIAL	FINISH	REMARKS	NO.	MATERIAL	FINISH	REMARKS
UNITS mm		SCALE 2 : 1	COUNT 	DESCRIPTION OF REVISIONS			
APPROVED : AR. SHIRAI 12.07.31				DRAWING NO. EDC3-166657-01			
CHECKED : NH. NAKATA 12.07.30				PART NO. GT25-24DP-2. 2V(C01)			
DESIGNED : TK. SHISHIKURA 12.07.30				CODE NO. CL775-0021-0-01			
DRAWN : TK. SHISHIKURA 12.07.30				1/1			

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Hirose Electric:](#)

[GT25-24DP-2.2V\(01\)](#)